

Top view LEDs 67-22/R6G6C-B09/2T



Features

- P-LCC-4 package
- Optical indicator
- Colorless clear window
- Ideal for backlight and light pipe application
- Inter reflector
- Wide viewing angle
- Suitable for vapor-phase reflow.
- Computable with automatic placement equipment
- Available on tape and reel (8mm Tape)
- Pb-free
- The product itself will remain within RoHS compliant version

Applications

- Telecommunication: indicator and backlighting in telephone and fax
- Flat backlight for LCD's, switches and symbols
- Light pipe application
- General use

Device Selection Guide

Chip Materials		Emitted Color	Resin Color
R6	AlGaInP	Brilliant-Red	Water clear
G6	AlGaInP	Brilliant Yellow Green	Water clear

Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Unit
Reverse Voltage	V_R	5	V
Forward Current	I_F	R6 25	mA
		G6 25	
Peak Forward Current	I_{FP}	R6 60	mA
		G6 60	
Power Dissipation	P_d	R6 60	mW
		G6 60	
Operating Temperature	T_{opr}	-40 ~ +85	°C
Storage Temperature	T_{stg}	-40 ~ +90	°C
Thermal Resistance	$R_{th\ J-A}$	500	K/W
	$R_{th\ J-S}$	300	K/W
ESD	ESD_{HBM}	2000	V
(Classification acc. AEC Q101)	ESD_{MM}	200	V
Soldering Temperature	T_{sol}	Reflow Soldering : 260 °C for 10 sec.	
		Hand Soldering : 350 °C for 3 sec.	

Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol		Min.	Typ.	Max.	Unit	Condition
Luminous Intensity	I_v	R6	57	-----	140	mcd	$I_F=20mA$
		G6	36	-----	90	mcd	
Viewing Angle	$2\theta 1/2$		-----	130	-----	deg	$I_F=20mA$
Peak Wavelength	λ_p	R6	-----	632	-----	nm	$I_F=20Ma$
		G6	-----	575	-----		
Dominant Wavelength	λ_d	R6	621	-----	627	nm	$I_F=20mA$
		G6	570	-----	574		
Spectrum Radiation Bandwidth	$\Delta\lambda$	R6	-----	20	-----	nm	$I_F=20mA$
		G6	-----	20	-----		
Forward Voltage	V_F	R6	1.75	-----	2.35	V	$I_F=20mA$
		G6	1.75	-----	2.35		
Reverse Current	I_R		-----	-----	10	μA	$V_R=5V$

Note:

1. Tolerance of Luminous Intensity: $\pm 11\%$
2. Tolerance of Dominant Wavelength: $\pm 1nm$
3. Tolerance of Forward Voltage: $\pm 0.1V$

Bin Range of Luminous Intensity

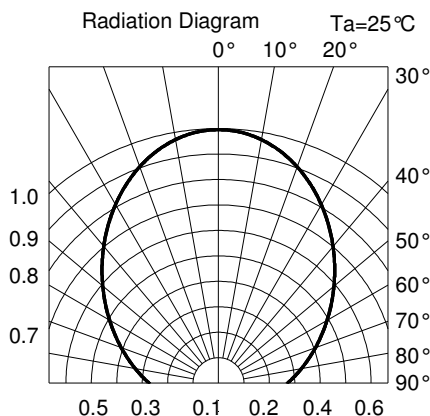
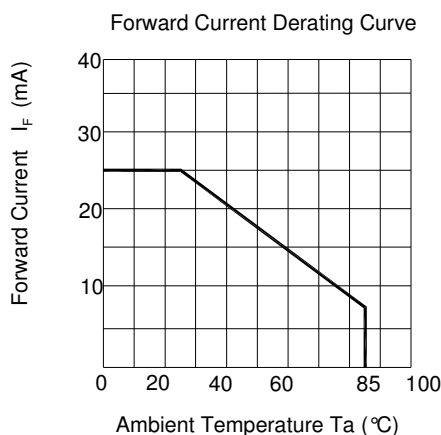
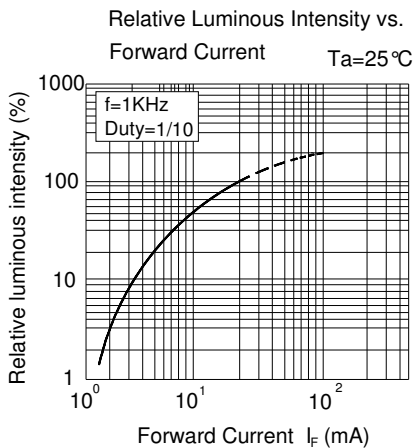
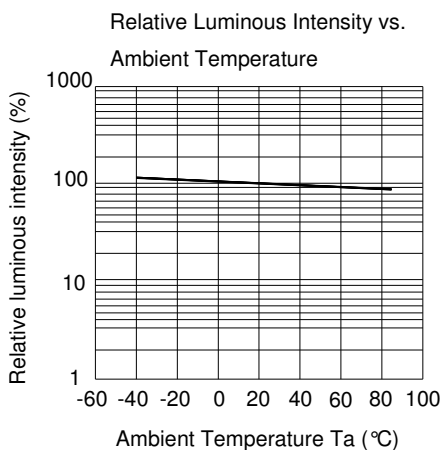
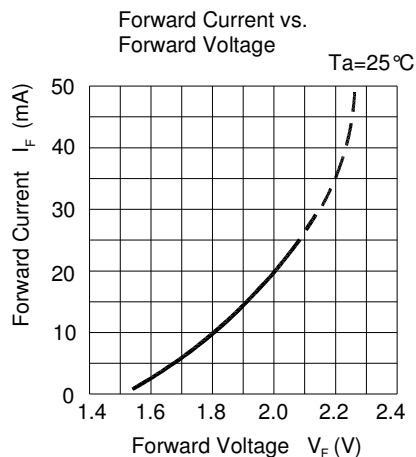
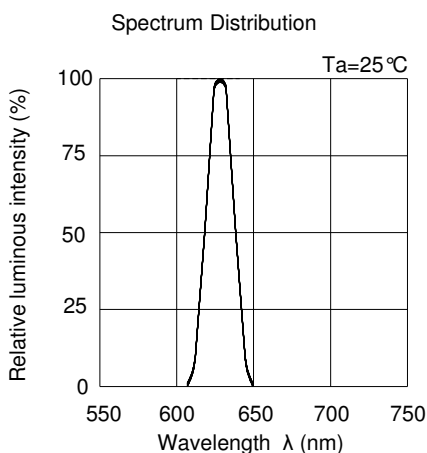
Chip	Bin Code	Min.	Max.	Unit	Condition
R6	P2	57	72	mcd	$I_F=20\text{mA}$
	Q1	72	90		
	Q2	90	112		
	R1	112	140		
G6	N2	36	45		
	P1	45	57		
	P2	57	72		
	Q1	72	90		

Bin Range of Forward Voltage

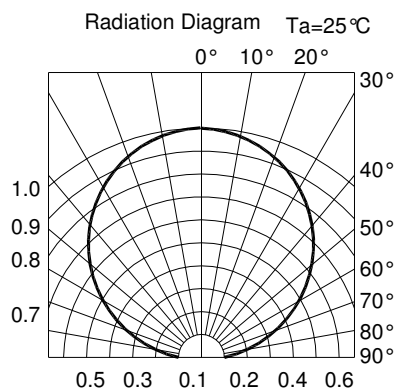
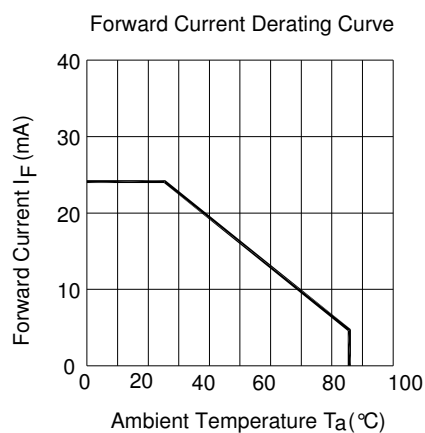
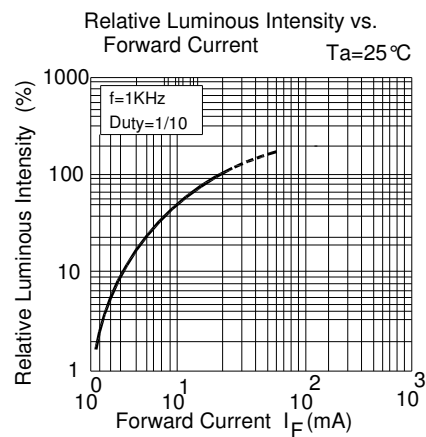
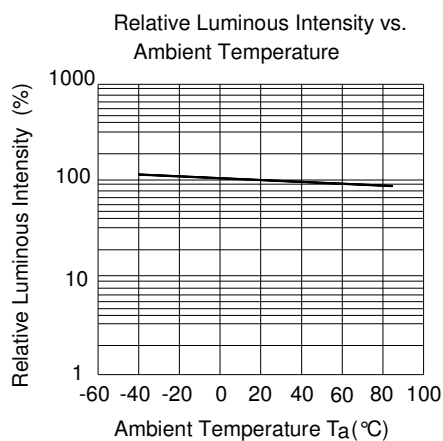
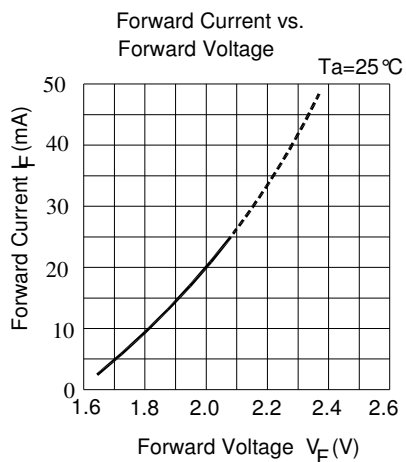
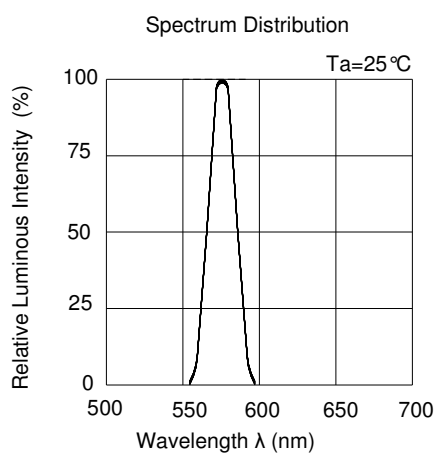
Chip	Bin Code	Min.	Max.	Unit	Condition
R6	0	1.75	1.95	V	$I_F=20\text{mA}$
	1	1.95	2.15		
	2	2.15	2.35		
G6	0	1.75	1.95		
	1	1.95	2.15		
	2	2.15	2.35		

Note:
Tolerance of Dominant Wavelength: $\pm 1\text{nm}$

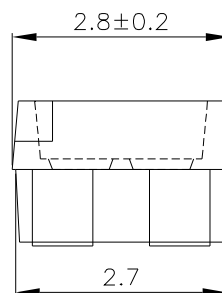
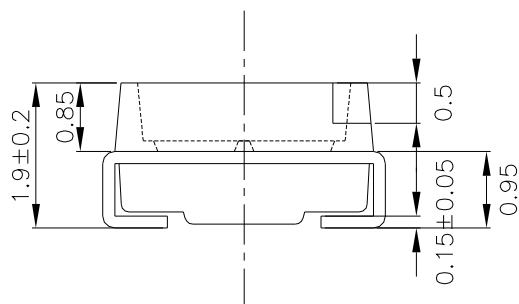
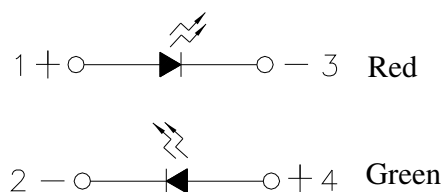
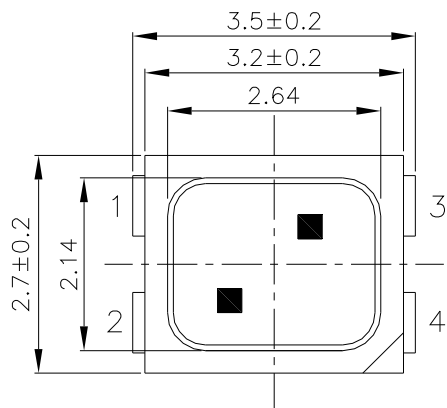
Typical Electro-Optical Characteristics Curves(R6)



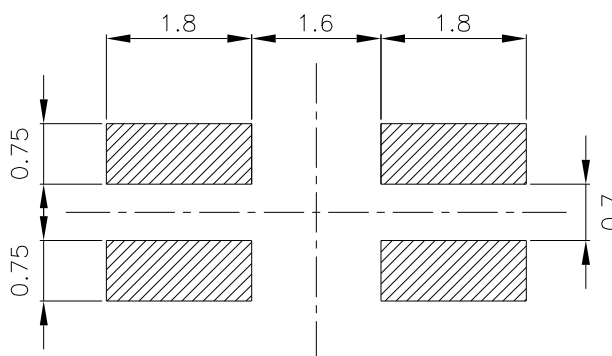
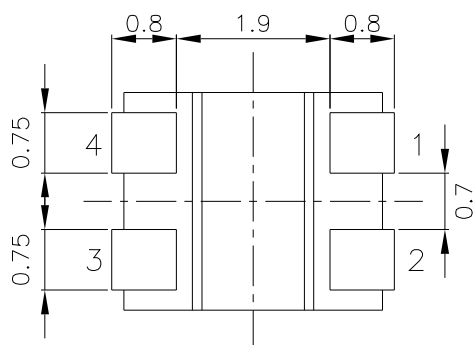
Typical Electro-Optical Characteristics Curves(G6)



Package Dimension



Recommended Solder Pad



Note: Tolerances unless mentioned ± 0.1 mm. Unit = mm

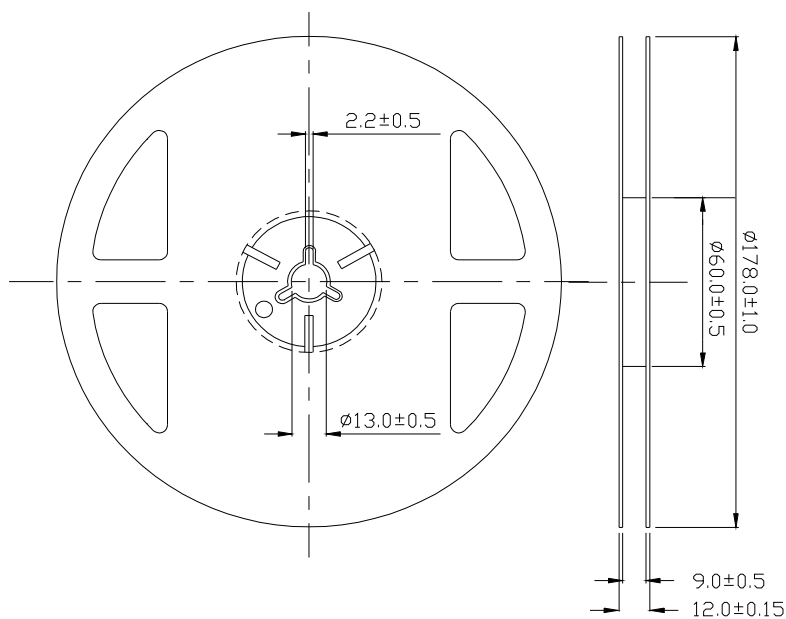
Moisture Resistant Packing Materials

Label Explanation

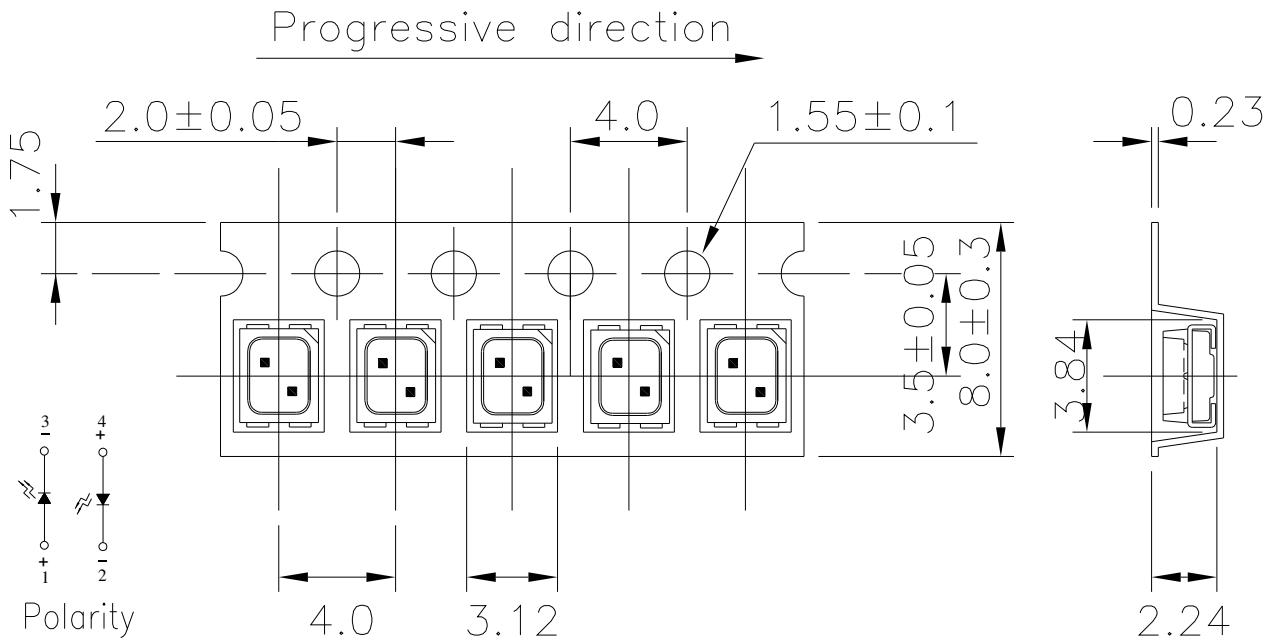


- CPN: Customer's Product Number
- P/N: Product Number
- QTY: Packing Quantity
- CAT: Luminous Intensity Rank
- HUE: Dom. Wavelength Rank
- REF: Forward Voltage Rank
- LOT No: Lot Number

Reel Dimensions

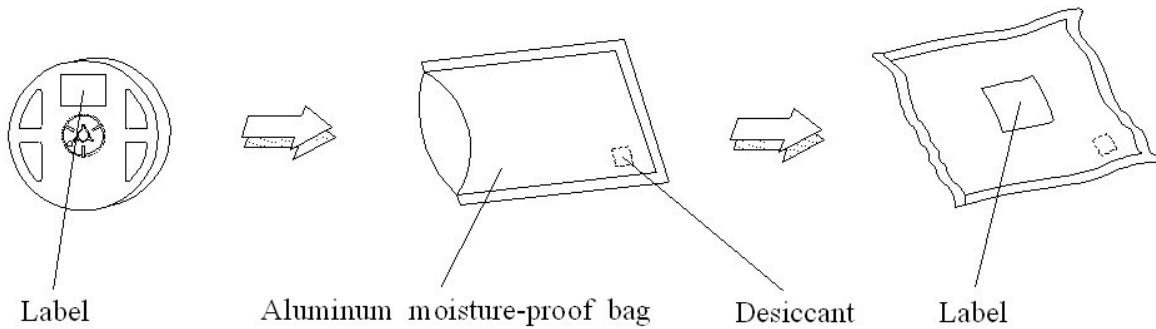


Carrier Tape Dimensions: Loaded Quantity 2000 pcs Per Reel



Note: Tolerances unless mentioned ± 0.1 mm. Unit = mm

Moisture Resistant Packing Process



Note: Tolerances unless mentioned ± 0.1 mm. Unit = mm

Precautions for Use

1. Over-current-proof

Customer must apply resistors for protection , otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

2.1 Do not open moisture proof bag before the products are ready to use.

2.2 Before opening the package, the LEDs should be kept at 30°C or less and 90%RH or less.

2.3 After opening the package: The LED's floor life are 168 hours under 30°C or less and 60% RH or less.

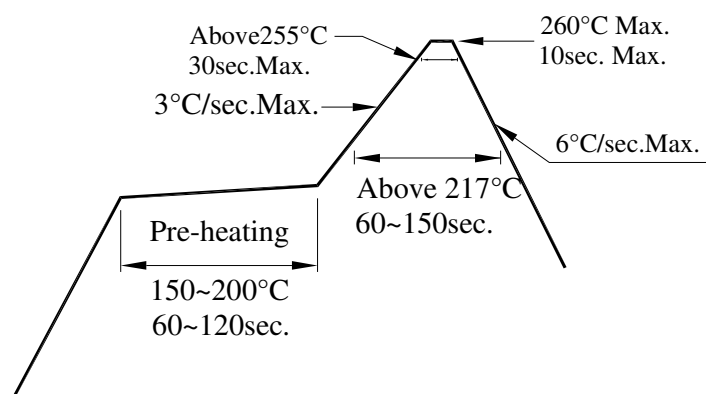
If unused LEDs remain, it should be stored in moisture proof packages.

2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment : 60±5°C for 24 hours.

3. Soldering Condition

3.1 Pb-free solder temperature profile



3.2 Reflow soldering should not be done more than two times.

3.3 When soldering, do not put stress on the LEDs during heating.

3.4 After soldering, do not warp the circuit board.

4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the

characteristics of the LEDs will or will not be damaged by repairing.

